Appl. No. 10/509,850 Amdt. dated December 18, 2007 Reply to Office Communication of April 13, 2007

Amendments to the Specification:

Please replace the first paragraph of the specification with the following amended paragraph:

The invention relates to a plasma spraying method in accordance with the preamble of claim 1. The generic process, described in US[[-A-]] <u>patent 5</u> 853 815, is a thermal spraying for the manufacture of a so-called LPPS (= low pressure plasma spraying) thin film. The invention also relates to applications of the method and to components which are coated in accordance with the method in accordance with the invention.